# MI1206K260R-10

# UNCONTROLLED DOCUMENT

# PHYSICAL DIMENSIONS:

**IMPEDANCE** 

 $^{\circ}$  1.10 [.043]  $^{+}$  0.20 [.008]

D 0.51 [.020] ± 0.25 [.010]

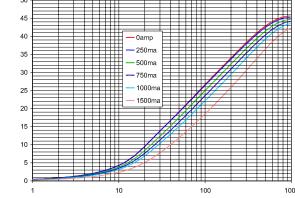
# A B

ELECTRICAL CHARACTERISTICS:											
Z @ 100M ( Ω )	1Hz	DCR ( $\Omega$ )	Rated Current								
Nominal	26										
Minimum	20										
Maximum	33	0.060	1500 mA								

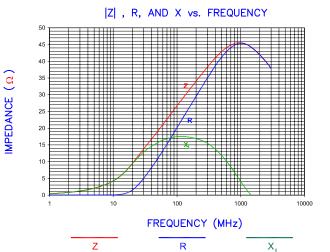
NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. TERMINATION FINISH IS 100% TIN.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

# Z vs FREQUENCY IMPEDANCE UNDER DC BIAS

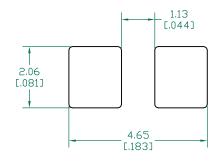


# FREQUENCY (MHz)



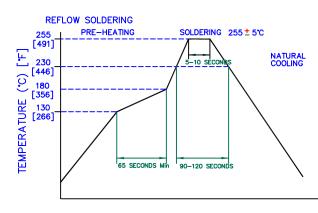
AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3298

## LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 (.030) to this dimension)

### RECOMMENDED SOLDERING CONDITIONS





	DIMENSIONS ARE IN mm [INCHE	ES].		This print is the property of Lai					
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				rights to design or invention are reserved.	•				
С	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	PROJECT/PART NUMBER:	П	REV	PART T	rPE:	DRAWN BY:
,	UPDATE LAIRD LOGO AND REFLOW CURV	E 08/03/13	ΨO	MI1206K260R-10		С	co-	-FIRE	JRK
В	UPDATE COMPANY LOGO ADD ROHS	8/20/08	JRK	DATE: 0.4 /4 T /0.4	SCA	I E:		SHEET:	
Α	ORIGINAL DRAFT	04/13/04	JEK	04/13/04		N	TS	J SHEET:	
REV	DESCRIPTION	DATE	INT	CAD #	TOC	∟# .	_	2	of 2